# Praetorian<sup>®</sup> L-C LCD and Camera EMI Filter Array with ESD Protection

## **Product Description**

The CM1690 is a family of pi-style EMI filter arrays with ESD protection, which integrates four, six and eight filters (C-L-C) in small form factor µDFN 0.40 mm pitch packages. Each EMI filter channel of the CM1690 is implemented as a 3-pole L-C filter where the component values are 16 pF - 12 nH - 16 pF. The CM1690's roll-off frequency at -6 dB attenuation is 330 MHz and can be used in applications where the data rates are as high as 140 Mbps while providing greater than -35 dB attenuation over the 1.0 GHz to 3.0 GHz frequency range. The parts include ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD protection diodes connected to the filter ports are designed and characterized to safely dissipate ESD strikes of ±15 kV, beyond the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than  $\pm 30$  kV.

This device is particularly well suited for wireless handsets, mobile LCD modules and PDAs because of its small package format and easy-to-use pin assignments. In particular, the CM1690 is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in mobile handsets.

The CM1690 is available in space saving, ultra low profile 8–, 12–, and 16–lead 0.40 mm  $\mu$ DFN packages with lead–free finishing.

## Features

- Four, Six and Eight Channels of EMI Filtering with Integrated ESD Protection
- Pi-Style EMI Filters in a Capacitor-Inductor-Capacitor (C-L-C) Network
- ±15 kV ESD Protection on Each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- ±30 kV ESD Protection on Each Channel (HBM)
- Greater than -35 dB Attenuation (Typical) at 1 GHz
- 0.50 mm Thick µDFN Package with 0.40 mm Lead Pitch:
  - 4-ch. = 8-lead  $\mu$ DFN
  - 6-ch. = 12-lead  $\mu$ DFN
  - 8-ch. = 16-lead  $\mu$ DFN
- Tiny µDFN Package Size:
  - 8-lead: 1.70 mm x 1.35 mm
  - 12-lead: 2.50 mm x 1.35 mm
  - 16-lead: 3.30 mm x 1.35 mm
- These Devices are Pb-Free and are RoHS Compliant

## Applications

- LCD and Camera Data Lines in Mobile Handsets
- Wireless Handsets
- LCD and Camera Modules



# **ON Semiconductor®**

http://onsemi.com



DE SUFFIX CASE 517BC

UDFN12 UDFN16 DE SUFFIX DE SUFFIX CASE 517BD CASE 517BE

## **ELECTRICAL SCHEMATIC**



\* See Package/Pinout Diagrams for expanded pin information.

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

r		
Device	Package	Shipping <sup>†</sup>
CM1690-04DE	μDFN-8 (Pb-Free)	3000/Tape & Reel
CM1690-06DE	μDFN–12 (Pb–Free)	3000/Tape & Reel
CM1690-08DE	μDFN–16 (Pb–Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## PACKAGE / PINOUT DIAGRAMS



#### **Table 1. PIN DESCRIPTIONS**

Device Pin(s)				De	Device Pin(s)		Device Pin(s)			
-04	-06	-08	Name	Description	-04	-06	-08	Name	Description	
1	1	1	FILTER1	Filter + ESD Channel 1	8	12	16	FILTER1	Filter + ESD Channel 1	
2	2	2	FILTER2	Filter + ESD Channel 2	7	11	15	FILTER2	Filter + ESD Channel 2	
3	3	3	FILTER3	Filter + ESD Channel 3	6	10	14	FILTER3	Filter + ESD Channel 3	
4	4	4	FILTER4	Filter + ESD Channel 4	5	9	13	FILTER4	Filter + ESD Channel 4	
-	5	5	FILTER5	Filter + ESD Channel 5	-	8	12	FILTER5	Filter + ESD Channel 5	
-	6	6	FILTER6	Filter + ESD Channel 6	-	7	11	FILTER6	Filter + ESD Channel 6	
-	-	7	FILTER7	Filter + ESD Channel 7	-	-	10	FILTER7	Filter + ESD Channel 7	
-	-	8	FILTER8	Filter + ESD Channel 8	-	-	9	FILTER8	Filter + ESD Channel 8	
G	and Pai	D	GND	Device Ground	-	-	-	-		

## SPECIFICATIONS

## Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
Current per Inductor	30	mA
DC Package Power Rating	500	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### **Table 3. STANDARD OPERATING CONDITIONS**

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

## Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
L	Channel Inductance			12		nH	
C <sub>TOTAL</sub>	Total Channel Capacitance     At 2.5 V DC Reverse Bias, 1 MHz, 30 mV AC			33	40	pF	
С	Capacitance C1	At 2.5 V DC Reverse Bias, 1 MHz, 30 mV AC		16.5		pF	
V <sub>DIODE</sub>	Stand-off Voltage	I <sub>DIODE</sub> = 10 μA		6.0		V	
I <sub>LEAK</sub>	Diode Leakage Current (Reverse Bias)	V <sub>DIODE</sub> = 3.3 V		0.1	0.3	μA	
V <sub>SIG</sub>	Signal Clamp Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10 mA I <sub>LOAD</sub> = -10 mA (Note 3)	5.6 -1.5	6.8 -0.8	9.0 -0.4	V	
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Notes 2 and 4)	±30 ±15			kV	
R <sub>DYN</sub>	Dynamic Resistance Positive Negative			2.3 0.9		Ω	
f <sub>C</sub>	Roll-off Frequency at -6 dB Attenuation $Z_{SOURCE}$ = 50 $\Omega$ , $Z_{LOAD}$ = 50 $\Omega$			330		MHz	
RINSULATION	Insulation Resistance	V <sub>DIODE</sub> = 3.3 V (Note 4)	10			MΩ	
R <sub>CHANNEL</sub>	Channel Resistance			8		Ω	

T<sub>A</sub> = 25°C unless otherwise specified.
ESD applied to input and output pins with respect to GND, one at a time.

Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin (i.e. if ESD is applied to pin A1 then clamping voltage is measured at pin C1).

4. Unused pins are left open.

## **PERFORMANCE INFORMATION**

## Typical Diode Capacitance vs. Input Voltage







Figure 2. Typical Performance Curve

#### PACKAGE DIMENSIONS

UDFN8, 1.7x1.35, 0.4P CASE 517BC-01 ISSUE O



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### PACKAGE DIMENSIONS

UDFN12, 2.5x1.35, 0.4P CASE 517BD-01 ISSUE O



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

UDFN16, 3.3x1.35, 0.4P CASE 517BE-01 ISSUE O



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PRAETORIAN is registered trademark of Semiconductor Components Industries, LCC (SCILLC).

ON Semiconductor and use registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other application in which the failure of the SCILLC product create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death agosociated with such unintended or unauthorized use persons, and reasonable attorney fees andigent design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5773–3850 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative